

**ELECTRICALLY INSULATING CROSSLINKED THIN-FILM-FORMING
ORGANIC RESIN COMPOSITION AND METHOD FOR FORMING
THIN FILM THEREFROM**

ABSTRACT

An electrically insulating crosslinked thin-film-forming organic resin composition comprising (A) an electrically insulating organic resin having silicon atom-bonded hydrogen atoms or silicon atom-bonded alkenyl groups and (B) a solvent, and a method for forming a crosslinked thin film therefrom.